Low-power configurable multiple function gate Rev. 2 — 1 December 2011 P

Product data sheet

1. **General description**

The 74LVC1G98 is a configurable multiple function gate with Schmitt-trigger inputs. The device can be configured as any of the following logic functions MUX, AND, OR, NAND, NOR, inverter and buffer; using the 3-bit input. All inputs can be connected to V_{CC} or GND.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. **Features and benefits**

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant input/output for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8B/JESD36 (2.7 V to 3.6 V).
- ± 24 mA output drive (V_{CC} = 3.0 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.



Low-power configurable multiple function gate

3. Ordering information

| Table 1. Orderi | ng information | | | | | | | | |
|-----------------|------------------------|---------|---|---------|--|--|--|--|--|
| Type number | Package | Package | | | | | | | |
| | Temperature range Name | | Description | Version | | | | | |
| 74LVC1G98GW | –40 °C to +125 °C | SC-88 | plastic surface-mounted package; 6 leads | SOT363 | | | | | |
| 74LVC1G98GV | –40 °C to +125 °C | SC-74 | plastic surface mounted package; 6 leads | SOT457 | | | | | |
| 74LVC1G98GM | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1.45 \times 0.5$ mm | SOT886 | | | | | |
| 74LVC1G98GF | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1 \times 0.5$ mm | SOT891 | | | | | |
| 74LVC1G98GN | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm | SOT1115 | | | | | |
| 74LVC1G98GS | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm | SOT1202 | | | | | |

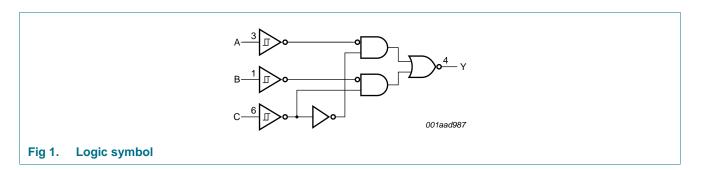
4. Marking

Table 2. Marking

| Type number | Marking code ^[1] |
|-------------|-----------------------------|
| 74LVC1G98GW | V9 |
| 74LVC1G98GV | V98 |
| 74LVC1G98GM | V9 |
| 74LVC1G98GF | V9 |
| 74LVC1G98GN | V9 |
| 74LVC1G98GS | V9 |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

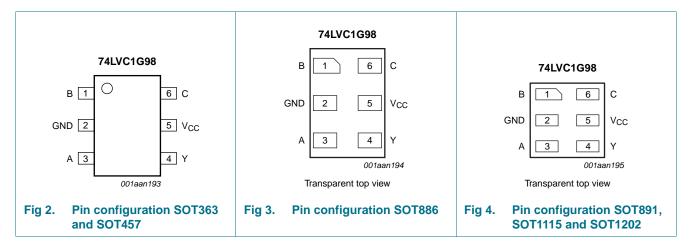
5. Functional diagram



Low-power configurable multiple function gate

6. Pinning information

6.1 Pinning



6.2 Pin description

| Table 3. | Pin description | |
|-----------------|-----------------|----------------|
| Symbol | Pin | Description |
| В | 1 | data input |
| GND | 2 | ground (0 V) |
| A | 3 | data input |
| Y | 4 | data output |
| V _{CC} | 5 | supply voltage |
| С | 6 | data input |

7. Functional description

| Table 4. | Function table ^[1] | | |
|----------|-------------------------------|---|--------|
| Input | | | Output |
| С | В | Α | Y |
| L | L | L | Н |
| L | L | Н | Н |
| L | Н | L | L |
| L | Н | Н | L |
| Н | L | L | Н |
| Н | L | Н | L |
| Н | Н | L | Н |
| Н | Н | Н | L |

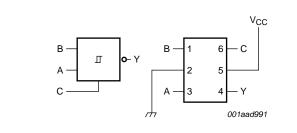
[1] H = HIGH voltage level; L = LOW voltage level.

Low-power configurable multiple function gate

7.1 Logic configurations

Table 5. Function selection table

| Logic function | Figure |
|--------------------------------------|---------------------|
| 2-input MUX with inverted output | see <u>Figure 5</u> |
| 2-input NAND | see <u>Figure 6</u> |
| 2-input NOR with one input inverted | see Figure 7 |
| 2-input AND with one input inverted | see Figure 7 |
| 2-input NAND with one input inverted | see Figure 8 |
| 2-input OR with one input inverted | see Figure 8 |
| 2-input NOR | see Figure 9 |
| Buffer | see Figure 10 |
| Inverter | see Figure 11 |



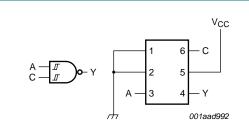


Fig 5. 2-input MUX with inverted output

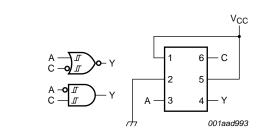


Fig 7. 2-input AND gate with input A inverted or 2-input NOR gate with inverted C input



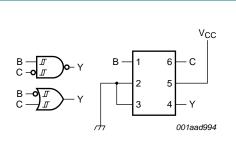
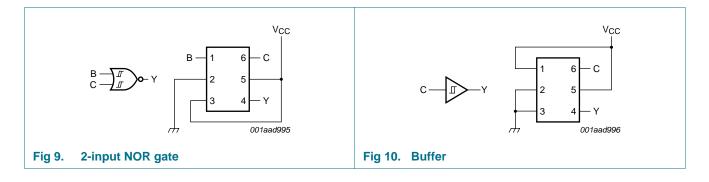
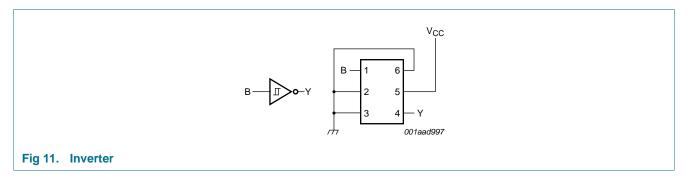


Fig 8. 2-input OR gate with input B inverted or 2-input NAND gate with input C inverted



Low-power configurable multiple function gate



8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|-------------------------|---|------------|------|------|------|
| V _{CC} | supply voltage | | | -0.5 | +6.5 | V |
| I _{IK} | input clamping current | V _I < 0 V | | -50 | - | mA |
| VI | input voltage | | <u>[1]</u> | -0.5 | +6.5 | V |
| I _{OK} | output clamping current | $V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V | | - | ±50 | mA |
| Vo | output voltage | Active mode | [1][2] | -0.5 | +6.5 | V |
| | | Power-down mode | [1][2] | -0.5 | +6.5 | V |
| lo | output current | $V_{O} = 0 V$ to V_{CC} | | - | ±50 | mA |
| I _{CC} | supply current | | | - | +100 | mA |
| I _{GND} | ground current | | | -100 | - | mA |
| T _{stg} | storage temperature | | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$ | [3] | - | 250 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When $V_{CC} = 0 V$ (Power-down mode), the output voltage can be 5.5 V in normal operation.

9. Recommended operating conditions

| Table 7. | Recommended operating co | nditions | | | | |
|------------------|--------------------------|----------------------------------|------|-----|-----------------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| V _{CC} | supply voltage | | 1.65 | - | 5.5 | V |
| VI | input voltage | | 0 | - | 5.5 | V |
| Vo | output voltage | Active mode | 0 | - | V _{CC} | V |
| | | $V_{CC} = 0 V$; Power-down mode | 0 | - | 5.5 | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |

74LVC1G98 Product data sheet

Low-power configurable multiple function gate

10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 | °C to +85 | °C | –40 °C to | Unit | |
|------------------|---------------------------------|---|----------------|----------------------|------|--------------|------|----|
| | | | Min | Typ <mark>[1]</mark> | Max | Min | Max | |
| V _{OL} | LOW-level | $V_I = V_{CC}$ or GND | | | | | | |
| | output voltage | I_{O} = 100 µA; V _{CC} = 1.65 V to 5.5 V | - | - | 0.1 | - | 0.1 | V |
| | | $I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.45 | - | 0.7 | V |
| | | I_{O} = 8 mA; V_{CC} = 2.3 V | - | - | 0.3 | - | 0.45 | V |
| | | I_0 = 12 mA; V_{CC} = 2.7 V | - | - | 0.4 | - | 0.6 | V |
| | | $I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | - | 0.8 | V |
| | | $I_0 = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | - | 0.55 | - | 0.8 | V |
| V _{OH} | HIGH-level output voltage | $V_I = V_{CC}$ or GND | | | | | | |
| | | $I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 5.5 \ V$ | $V_{CC} - 0.1$ | - | - | $V_{CC}-0.1$ | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | - | - | 0.95 | - | V |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.9 | - | - | 1.7 | - | V |
| | | $I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 2.2 | - | - | 1.9 | - | V |
| | | $I_0 = -24$ mA; $V_{CC} = 3.0$ V | 2.3 | - | - | 2.0 | - | V |
| | | $I_0 = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.8 | - | - | 3.4 | - | V |
| I | input leakage current | V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V | - | ±0.1 | ±5 | - | ±100 | μA |
| IOFF | power-off leakage current | $V_{I} \text{ or } V_{O} = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$ | - | ±0.1 | ±10 | - | ±200 | μΑ |
| I _{CC} | supply current | $V_{I} = 5.5 V \text{ or GND}; I_{O} = 0 A;$ $V_{CC} = 1.65 V \text{ to } 5.5 V$ | - | 0.1 | 10 | - | 200 | μA |
| ∆l _{CC} | additional supply current | | - | 5 | 500 | - | 5000 | μA |
| CI | input capacitance | | - | 2.5 | - | - | - | pF |

[1] Typical values are measured at maximum V_{CC} and T_{amb} = 25 °C.

Low-power configurable multiple function gate

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 13</u>.

| Symbol | Parameter | Conditions | | –40 °C to +85 °C | | | –40 °C to | Unit | |
|-----------------|-------------------------------|--|------------|------------------|----------------------|------|-----------|------|----|
| | | | | Min | Typ <mark>[1]</mark> | Max | Min | Max | |
| t _{pd} | propagation delay | A, B, C to Y; see Figure 12 | [2] | | | | | | |
| | | V_{CC} = 1.65 V to 1.95 V | | 1.0 | 6.0 | 14.4 | 1.0 | 18.0 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 0.5 | 3.5 | 8.3 | 0.5 | 10.4 | ns |
| | | $V_{CC} = 2.7 V$ | | 0.5 | 4.2 | 8.5 | 0.5 | 10.6 | ns |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | | 0.5 | 3.8 | 6.3 | 0.5 | 7.9 | ns |
| | | $V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$ | | 0.5 | 3.0 | 5.1 | 0.5 | 6.4 | ns |
| C_{PD} | power dissipation capacitance | V_{CC} = 3.3 V; V_{I} = GND to V_{CC} | <u>[3]</u> | - | 20 | - | - | - | pF |

[1] Typical values are measured at nominal V_{CC} and at $T_{amb} = 25$ °C.

[2] t_{pd} is the same as t_{PLH} and t_{PHL}

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

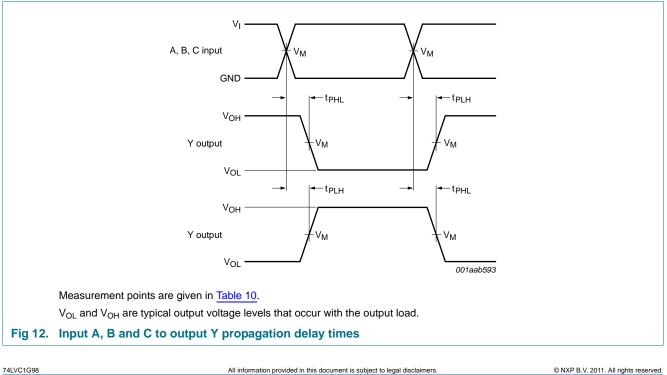
 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

12. Waveforms



Product data sheet

NXP Semiconductors

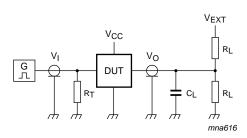
Maggiurgment neinte

Table 40

74LVC1G98

Low-power configurable multiple function gate

| Supply voltage | Input | | Output | |
|------------------|--------------------|-----------------|--------------------|--|
| V _{cc} | V _M | VI | V _M | |
| 1.65 V to 1.95 V | 0.5V _{CC} | V _{CC} | 0.5V _{CC} | |
| 2.3 V to 2.7 V | $0.5V_{CC}$ | V _{CC} | 0.5V _{CC} | |
| 2.7 V | 1.5 V | 2.7 V | 1.5 V | |
| 3.0 V to 3.6 V | 1.5 V | 2.7 V | 1.5 V | |
| 4.5 V to 5.5 V | 0.5V _{CC} | V _{CC} | 0.5V _{CC} | |



Measurement points are given in Table 11.

Definitions test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 13. Test circuit for measuring switching times

Table 11. Measurement points

| Supply voltage | Input | | Load | | V _{EXT} |
|------------------|-----------------|---------------|-------|-------|-------------------------------------|
| V _{CC} | VI | $t_r = t_f$ | CL | RL | t _{PLH} , t _{PHL} |
| 1.65 V to 1.95 V | V _{CC} | \leq 2.0 ns | 30 pF | 1 kΩ | open |
| 2.3 to 2.7 V | V _{CC} | \leq 2.0 ns | 30 pF | 500 Ω | open |
| 2.7 V | 2.7 V | \leq 2.5 ns | 50 pF | 500 Ω | open |
| 3.0 V to 3.6 V | 2.7 V | \leq 2.5 ns | 50 pF | 500 Ω | open |
| 4.5 V to 5.5 V | V _{CC} | \leq 2.5 ns | 50 pF | 500 Ω | open |

Low-power configurable multiple function gate

13. Transfer characteristics

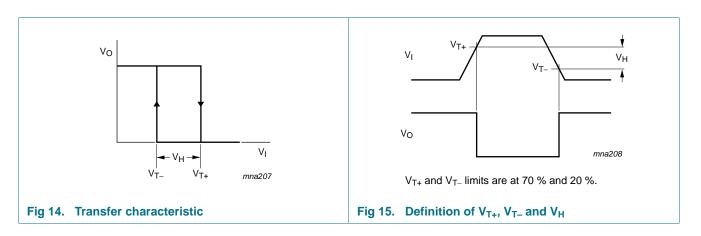
Table 12. Transfer characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 | –40 °C to +85 °C | | | –40 °C to +125 °C | | |
|----------------|-------------------------------------|---|------|------------------|------|------|-------------------|---|--|
| | | | Min | Typ[1] | Max | Min | Max | | |
| V_{T+} | positive-going threshold voltage | see <u>Figure 14</u> , <u>Figure 15</u> , <u>Figure 16</u> and <u>Figure 17</u> | | | | | | | |
| | | V _{CC} = 1.8 V | 0.70 | 1.02 | 1.20 | 0.67 | 1.20 | V | |
| | | $V_{CC} = 2.3 V$ | 1.11 | 1.42 | 1.60 | 1.08 | 1.60 | V | |
| | | $V_{CC} = 3.0 V$ | 1.50 | 1.79 | 2.00 | 1.47 | 2.00 | V | |
| | | $V_{CC} = 4.5 V$ | 2.16 | 2.52 | 2.74 | 2.13 | 2.74 | V | |
| | | $V_{CC} = 5.5 V$ | 2.61 | 2.99 | 3.33 | 2.58 | 3.33 | V | |
| V_{T-} | negative-going threshold voltage | see Figure 14, Figure 15, Figure 16 and Figure 17 | | | | | | | |
| | | V _{CC} = 1.8 V | 0.30 | 0.53 | 0.72 | 0.30 | 0.75 | V | |
| | | $V_{CC} = 2.3 V$ | 0.58 | 0.77 | 1.00 | 0.58 | 1.03 | V | |
| | | $V_{CC} = 3.0 V$ | 0.80 | 1.04 | 1.30 | 0.80 | 1.33 | V | |
| | | $V_{CC} = 4.5 V$ | 1.21 | 1.55 | 1.90 | 1.21 | 1.93 | V | |
| | | $V_{CC} = 5.5 V$ | 1.45 | 1.86 | 2.29 | 1.45 | 2.32 | V | |
| V _H | hysteresis voltage | (V _{T+} – V _T _) See <u>Figure 14, Figure 15,</u> <u>Figure 16</u> and <u>Figure 17</u> | | | | | | | |
| | | V _{CC} = 1.8 V | 0.30 | 0.48 | 0.62 | 0.23 | 0.62 | V | |
| | | $V_{CC} = 2.3 V$ | 0.40 | 0.64 | 0.80 | 0.34 | 0.80 | V | |
| | | $V_{CC} = 3.0 V$ | 0.50 | 0.75 | 1.00 | 0.44 | 1.00 | V | |
| | | $V_{CC} = 4.5 V$ | 0.71 | 0.97 | 1.20 | 0.65 | 1.20 | V | |
| | | $V_{CC} = 5.5 V$ | 0.71 | 1.13 | 1.40 | 0.65 | 1.40 | V | |

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

14. Waveforms transfer characteristics

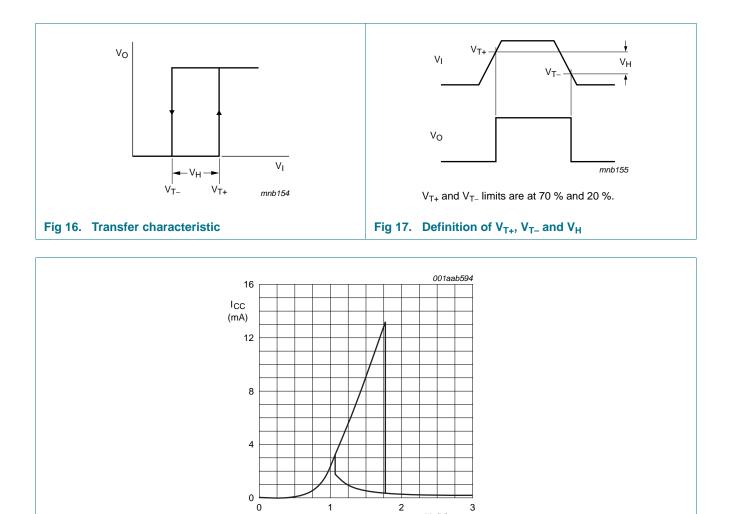


74LVC1G98 **Product data sheet**

NXP Semiconductors

74LVC1G98

Low-power configurable multiple function gate



V_I (V)

Fig 18. Typical 74LVC1G98 transfer characteristic; $V_{CC} = 3.0 V$

74LVC1G98 Product data sheet

NXP Semiconductors

74LVC1G98

Low-power configurable multiple function gate

15. Package outline

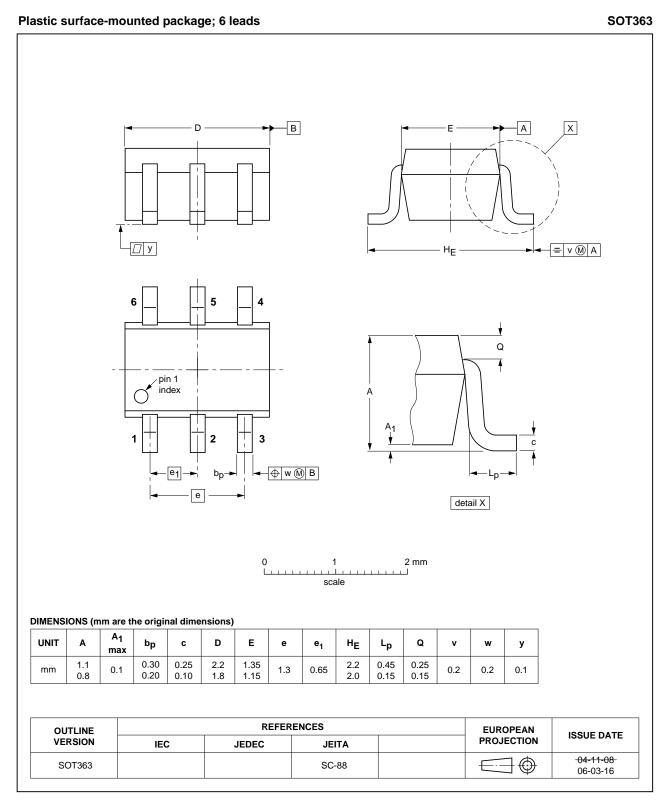


Fig 19. Package outline SOT363 (SC-88)

All information provided in this document is subject to legal disclaimers.

Low-power configurable multiple function gate

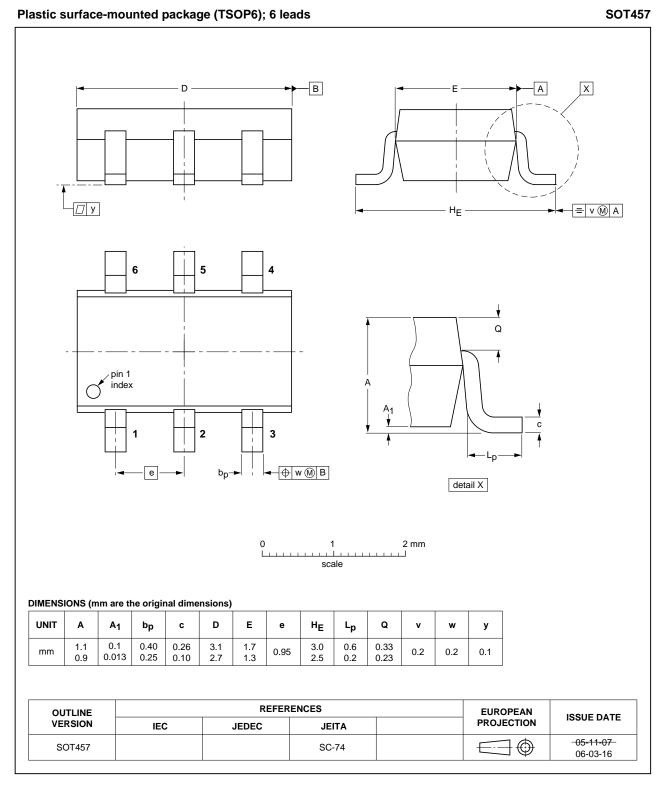
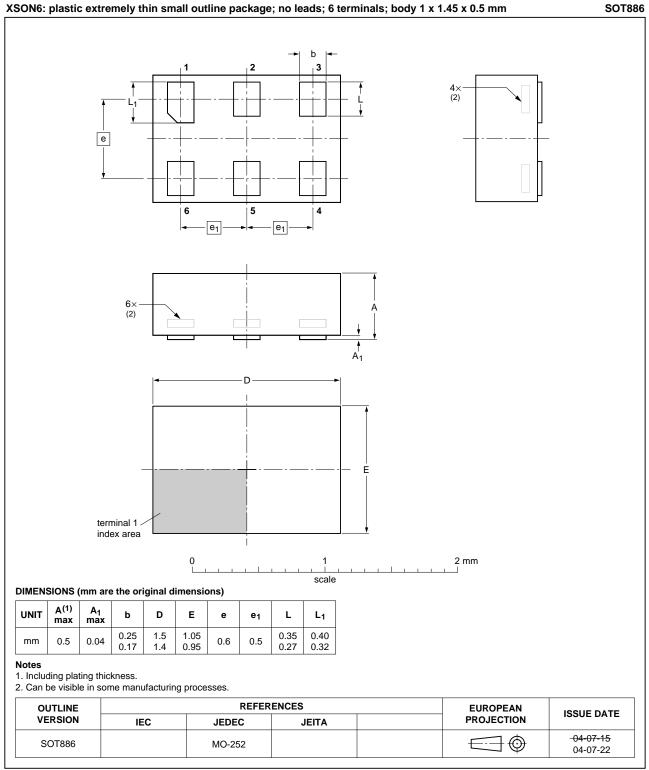


Fig 20. Package outline SOT457 (SC-74)

All information provided in this document is subject to legal disclaimers.

Low-power configurable multiple function gate



XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

Fig 21. Package outline SOT886 (XSON6)

All information provided in this document is subject to legal disclaimers.

Low-power configurable multiple function gate

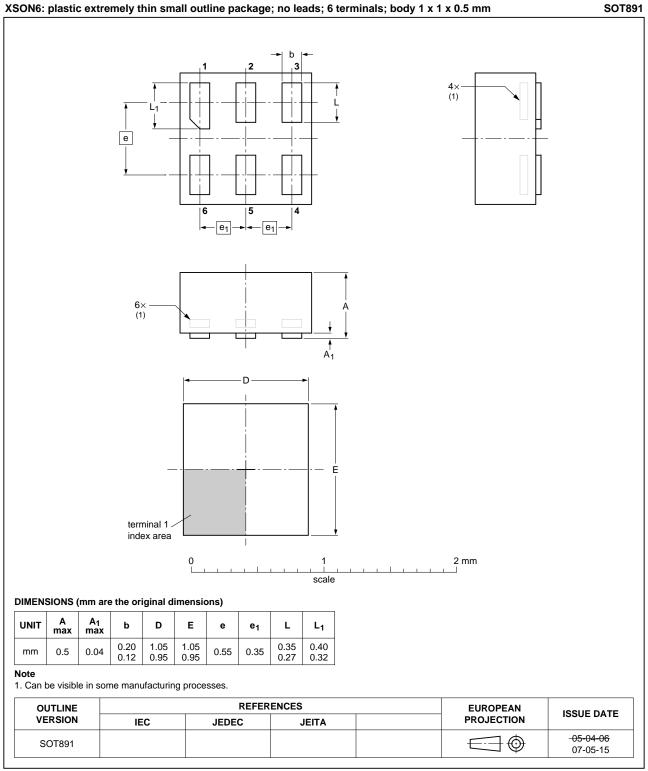
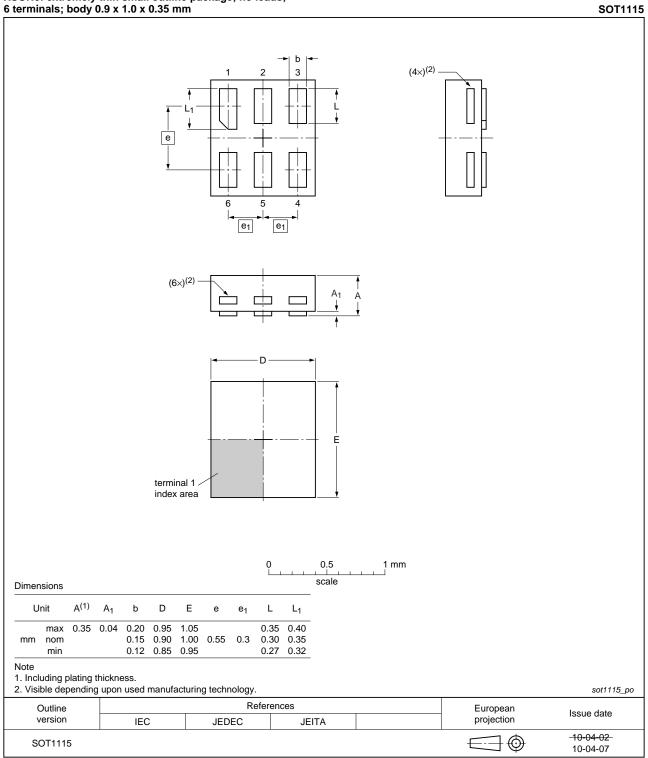


Fig 22. Package outline SOT891 (XSON6)

74LVC1G98

14 of 20

Low-power configurable multiple function gate



XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

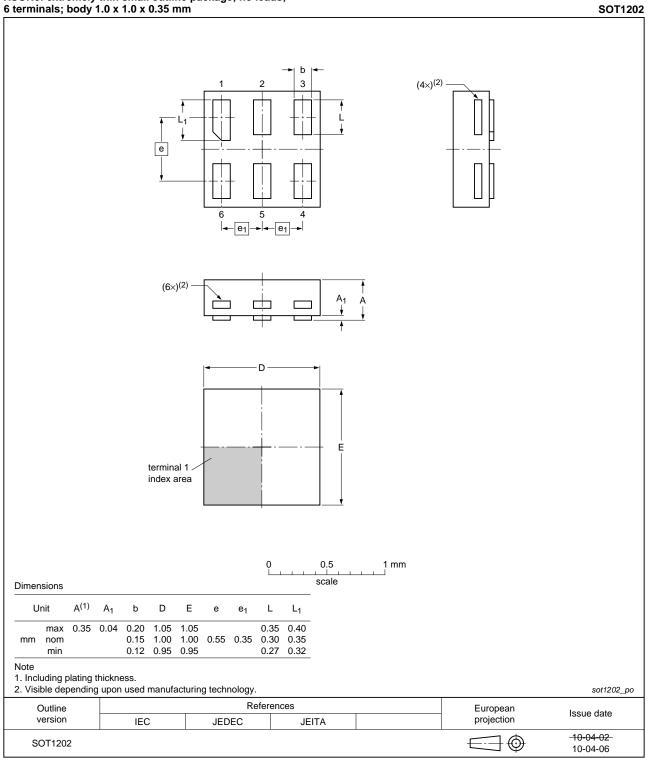
Fig 23. Package outline SOT1115 (XSON6)

| II information | provided in | this | document is | subject | to | legal | disclaimer | s. |
|----------------|-------------|------|-------------|---------|----|-------|------------|----|
| | | | | | | | | |

74LVC1G98

A

Low-power configurable multiple function gate



XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 24. Package outline SOT1202 (XSON6)

All information provided in this document is subject to legal disclaimers.

Low-power configurable multiple function gate

16. Abbreviations

| Table 13. Abbreviations | | |
|-------------------------|---|--|
| Acronym | Description | |
| CDM | Charged Device Model | |
| CMOS | Complementary Metal Oxide Semiconductor | |
| TTL | Transistor-Transistor Logic | |
| HBM | Human Body Model | |
| ESD | ElectroStatic Discharge | |
| MM | Machine Model | |
| DUT | Device Under Test | |
| | | |

17. Revision history

| Table 14. Revision hist | ory | | | |
|-------------------------|---------------------------------|--------------------|---------------|---------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| 74LVC1G98 v.2 | 20111201 | Product data sheet | - | 74LVC1G98 v.1 |
| Modifications: | Legal pages | updated. | | |
| 74LVC1G98 v.1 | 20101221 | Product data sheet | - | - |

Low-power configurable multiple function gate

18. Legal information

18.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

18.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

18.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Low-power configurable multiple function gate

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

19. Contact information

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

18.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

Low-power configurable multiple function gate

20. Contents

| 1 | General description 1 |
|------|------------------------------------|
| 2 | Features and benefits 1 |
| 3 | Ordering information 2 |
| 4 | Marking 2 |
| 5 | Functional diagram 2 |
| 6 | Pinning information 3 |
| 6.1 | Pinning 3 |
| 6.2 | Pin description 3 |
| 7 | Functional description 3 |
| 7.1 | Logic configurations 4 |
| 8 | Limiting values 5 |
| 9 | Recommended operating conditions 5 |
| 10 | Static characteristics 6 |
| 11 | Dynamic characteristics 7 |
| 12 | Waveforms 7 |
| 13 | Transfer characteristics 9 |
| 14 | Waveforms transfer characteristics |
| 15 | Package outline 11 |
| 16 | Abbreviations 17 |
| 17 | Revision history 17 |
| 18 | Legal information 18 |
| 18.1 | Data sheet status 18 |
| 18.2 | Definitions 18 |
| 18.3 | Disclaimers |
| 18.4 | Trademarks |
| 19 | Contact information 19 |
| 20 | Contents |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2011.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 1 December 2011 Document identifier: 74LVC1G98